

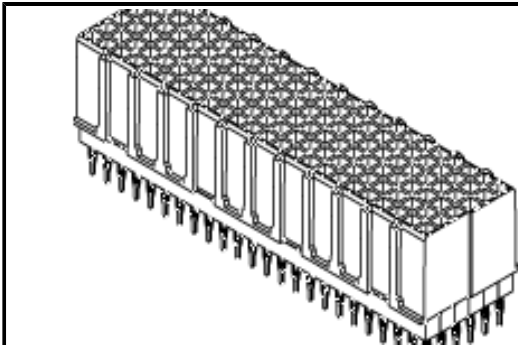
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Part Number: [0737802243](#)
Status: **Active**
Overview: [HDM® Backplane Connector System](#)
Description: HDM® Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, 72 Circuits, Mounted Height 13.00mm, Pin Length 3.00mm, Press-Fit

Documents:
[3D Model](#)
[Drawing \(PDF\)](#)
[Product Specification PS-73780-999-001 \(PDF\)](#)
[Product Specification TS-73670-990-001 \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification	
UL	E29179
General	
Product Family	Backplane Connectors
Series	73780
Application	Daughtercard, Mezzanine
Comments	Press-Fit Tail
Component Type	PCB Receptacle
Overview	HDM® Backplane Connector System
Product Name	HDM®
UPC	800756059938

Physical	
Circuits (Loaded)	72
Circuits (maximum)	72
Color - Resin	Black
Durability (mating cycles max)	250
First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Copper-Nickel-Tin
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Net Weight	9.498/g
Number of Columns	12
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length	3.00mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Packaging Type	Tube
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.762µm
Plating min - Termination	0.889µm
Polarized to PCB	No
Stackable	Yes
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin



Series image - Reference only

EU ELV
Not Relevant

EU RoHS Compliant REACH SVHC Not Contained Per - ED/21/2016 (20 June 2016) Halogen-Free Status Low-Halogen Need more information on product environmental compliance? Email productcompliance@molex.com Please visit the Contact Us section for any non-product compliance questions.	China RoHS China ROHS ELV RoHS Phthalates
	Green Image Not Relevant Not Contained

Search Parts in this Series
[73780](#) Series

Mates With
HDM® Board-to-Board Backplane Header
[73642](#) , [73643](#) , [73644](#) , [73942](#) , [73943](#) ,
[73944](#) , [7 4349](#), [74428](#). HDM® Board-to-
Board Stacking Header [73769](#) , [73770](#) ,
[73782](#) , [73783](#) , [73771](#)

Electrical

Current - Maximum per Contact	15.0A, 1.0A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

Solder Process Data

Lead-freeProcess Capability	N/A
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Material Info

Reference - Drawing Numbers

Product Specification	PS-73780-999-001, TS-73670-990-001
Sales Drawing	SD-73780-001

Note: HDM, HDM+, VHDM, VHDM-HSD and GbX are trademarks or registered trademarks of Amphenol TCS.

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